

Electrical Performance

Parameter		Min.	Typ.	Max.	Units	Notes
Output frequency		1.544		100	MHz	As specified
Supply voltage		+1.71	+1.8	+1.89	V	
Supply current, output enabled				4	mA	<36 MHz
				7		36 to 50 MHz
				10		>70 to 100 MHz
				20		>50 to 70 MHz
Supply current, standby mode				10	μA	1.544 to <36 MHz
				100	μA	36 to 70 MHz
Frequency stability				±50	ppM	See Note 1 below
Operating temperature		0		+70	°C	As specified
Output logic 0, VOL				10% V _{DD}	V	
Output logic 1, VOH		90% V _{DD}			V	
Output load		15 pF (max)				
Duty cycle		45		55	%	measured 50%VDD
Rise and fall time	up to <36 MHz			4	ns	measured 20/80% of waveform
	36 to 70 MHz			2.5		
Jitter, Phase	up to 80 MHz			1.5	ps RMS (1-σ)	10kHz to 20 MHz frequency band
	>80 to 125 MHz			1		
Jitter, Accumulated	up to 80 MHz			5	ps RMS (1-σ)	20.000 adjacent periods
	>80 to 125 MHz			3		
Jitter, Total	up to 80 MHz			50	ps pk-pk	100.000 random periods
	>80 to 125 MHz			30		

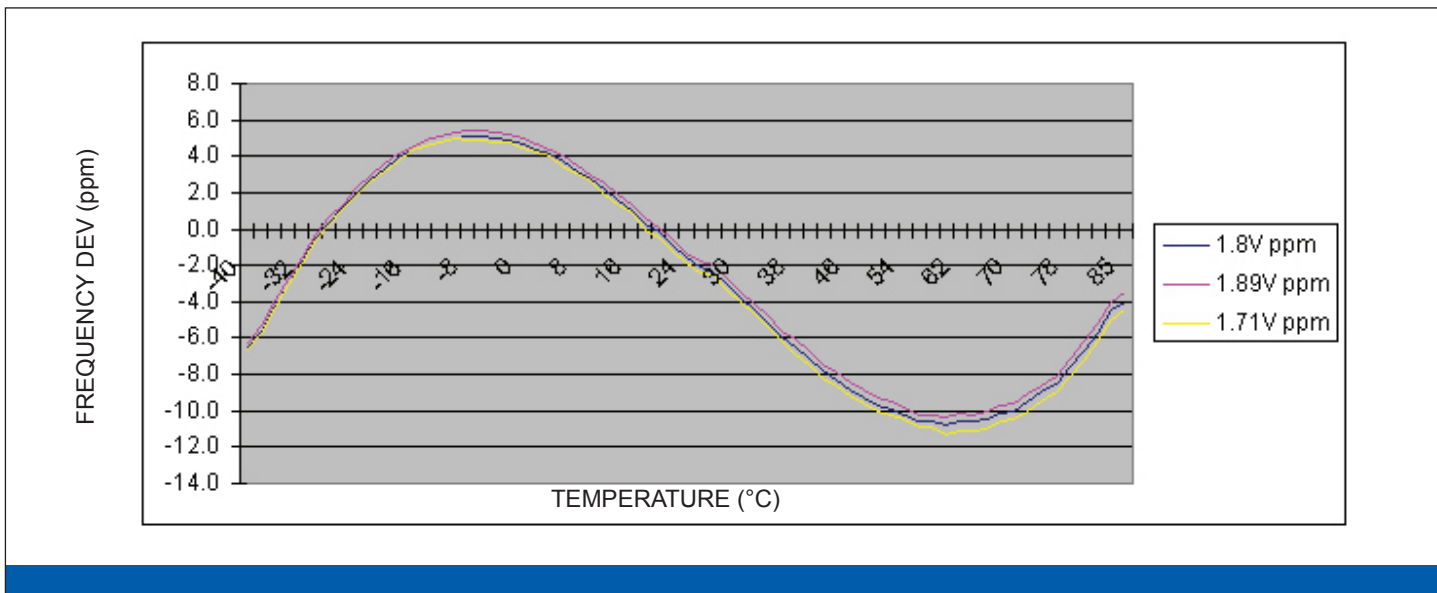
Notes:

- As specified. Stability includes all combinations of operating temperature, load changes, rated input (supply) voltage changes, initial calibration tolerance (25°C), aging (1 year at 25°C average effective ambient temperature), shock and vibration.
- Note: For specifications other than those listed, please contact sales.

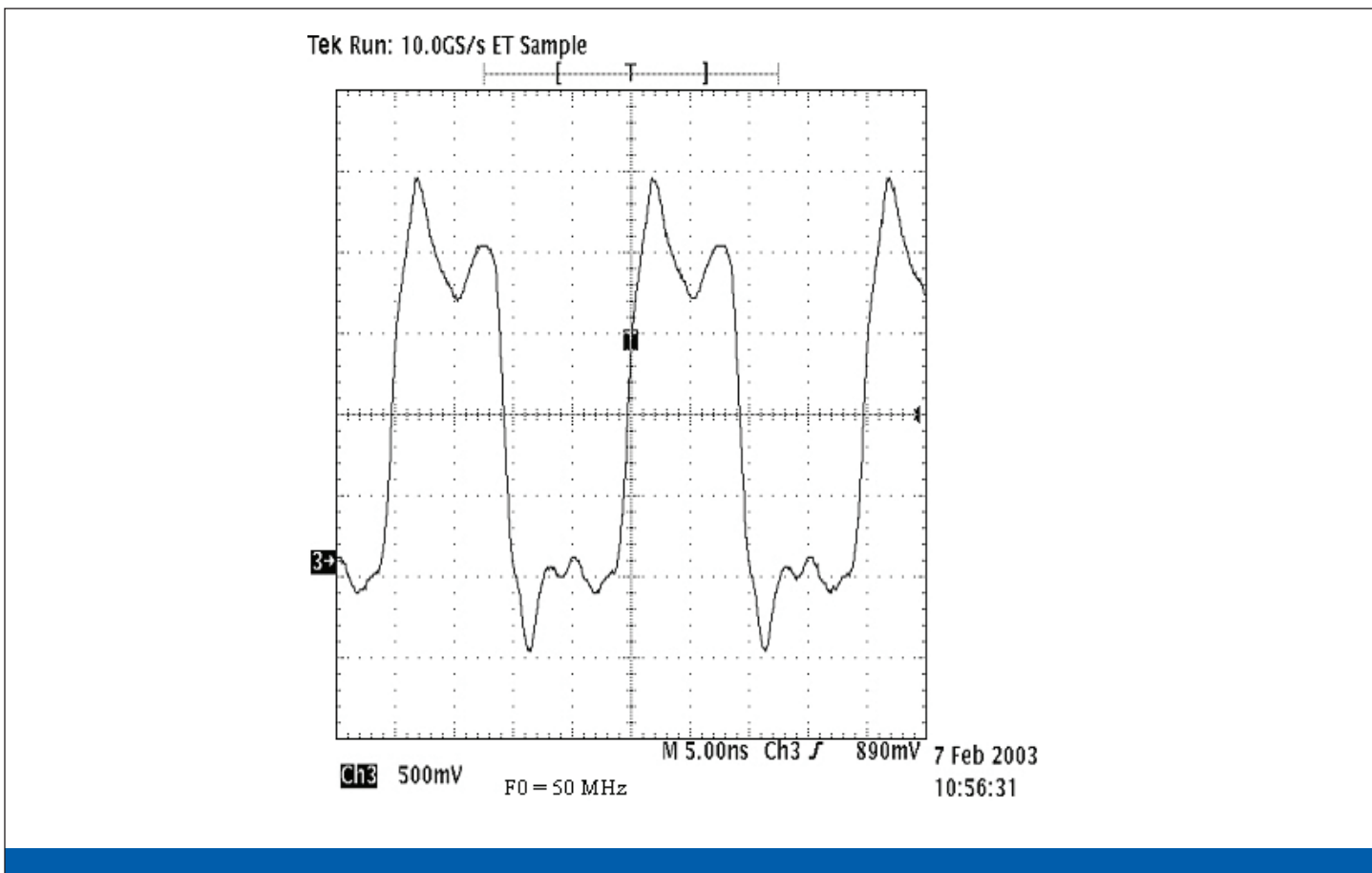
Output Enable / Disable Function

Parameter		Min.	Typ.	Max.	Units	Notes
Input Voltage (pin 1), Output Enable		0.7V _{DD}			V	or open
Input voltage (pin 1), Output Disable (low power standby)				0.3V _{DD}	V	Output is Hi-Z
Internal pullup resistance		30			kΩ	
Output disable delay				200	ns	
Output enable delay				10	ms	

Typical Frequency Stability



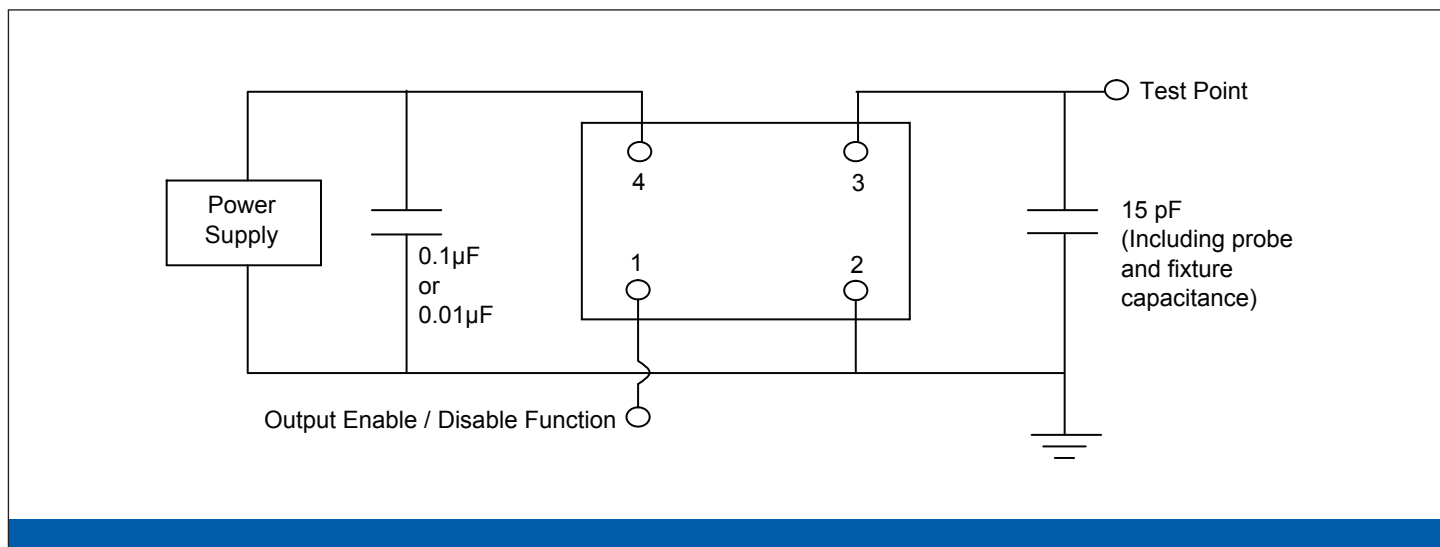
Typical Output Waveform



Absolute Maximum Ratings

Parameter	Min.	Typ.	Max.	Units	Notes
Storage temperature	-55		+125	°C	

Test Circuit

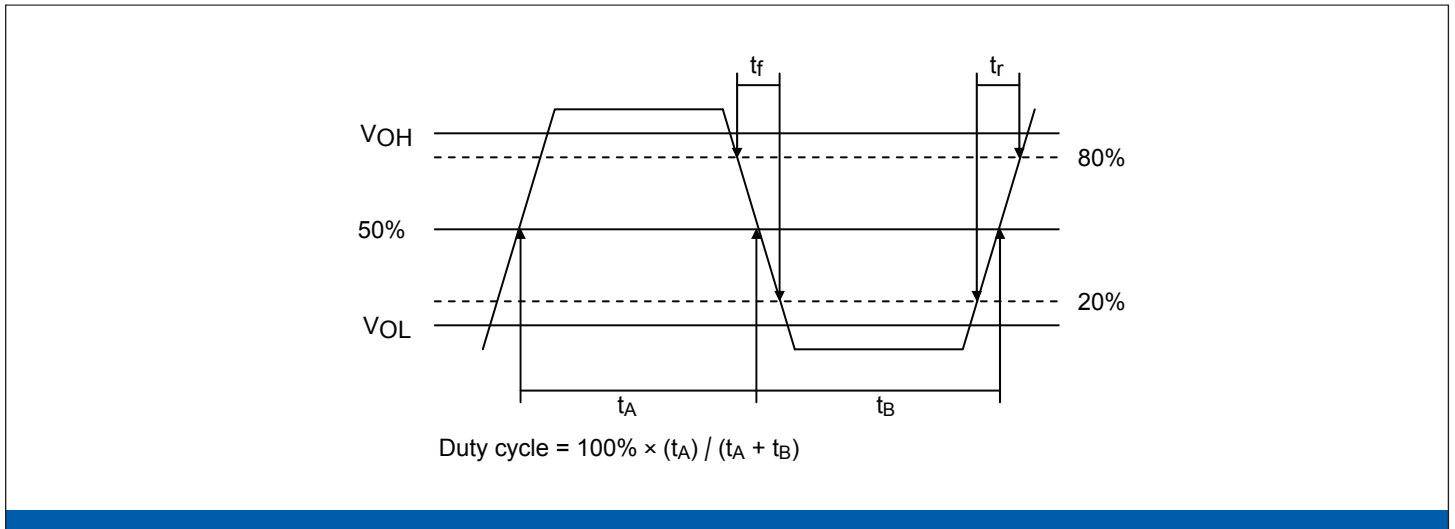


Reliability Test Ratings

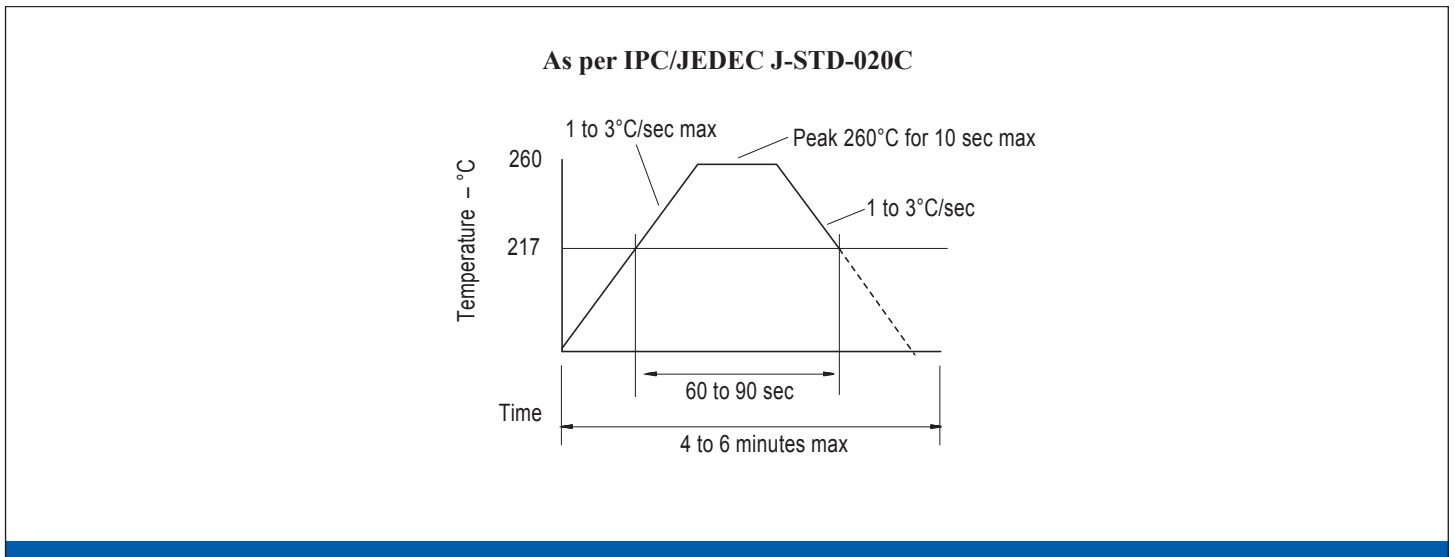
This product is rated to meet the following test conditions:

Type	Parameter	Test Condition
Mechanical	Shock	MIL-STD-883, Method 2002, Condition B
Mechanical	Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Mechanical	Terminal strength	MIL-STD-883, Method 2004, Condition D
Mechanical	Gross leak	MIL-STD-883, Method 1014, Condition C
Mechanical	Fine leak	MIL-STD-883, Method 1014, Condition A2 ($R_1 = 2 \times 10^{-8}$ atm cc/s)
Mechanical	Solvent resistance	MIL-STD-202, Method 215
Environmental	Thermal shock	MIL-STD-883, Method 1011, Condition A
Environmental	Moisture resistance	MIL-STD-883, Method 1004
Environmental	Vibration	MIL-STD-883, Method 2007, Condition A
Environmental	Resistance to soldering heat	J-STD-020C Table 5-2 Pb-free devices (2 cycles max)

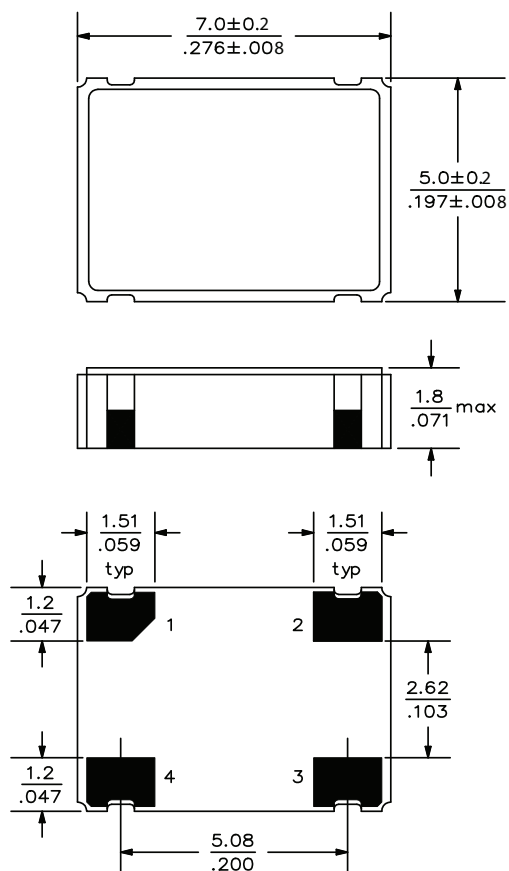
Output Waveform



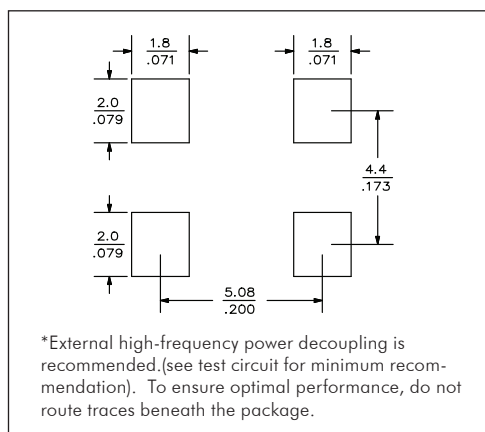
Reflow Soldering Profile



Mechanical Drawings



Recommended Land Pattern*



Scale: None. Dimensions are in mm/inches.